



**GP**  
**ELECTRONICS**

**GPM014N03NNC**

**30V N-Channel MOSFET**

### Product Summary

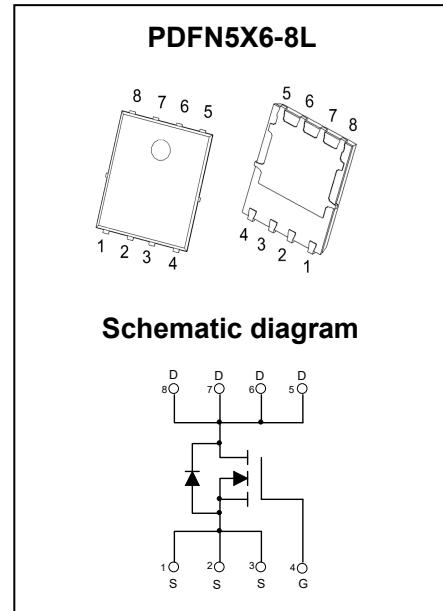
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
30V	1.05mΩ@10V	180A
	1.4mΩ@4.5V	

### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

### Application

- Power Switching Application



### MARKING:



M014N03N = Device Code  
XX = Date Code  
Solid Dot = Green Indicator

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

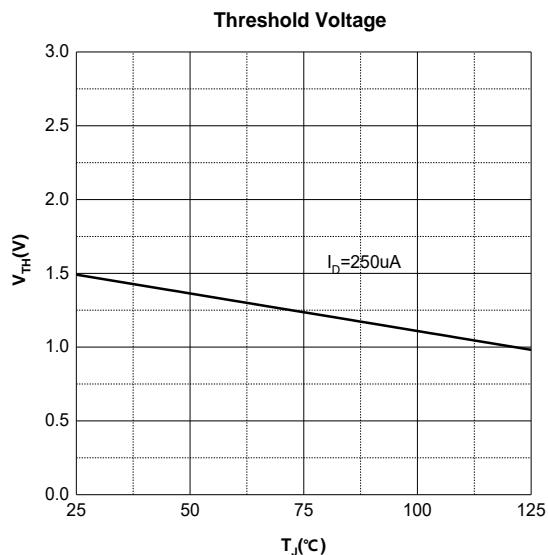
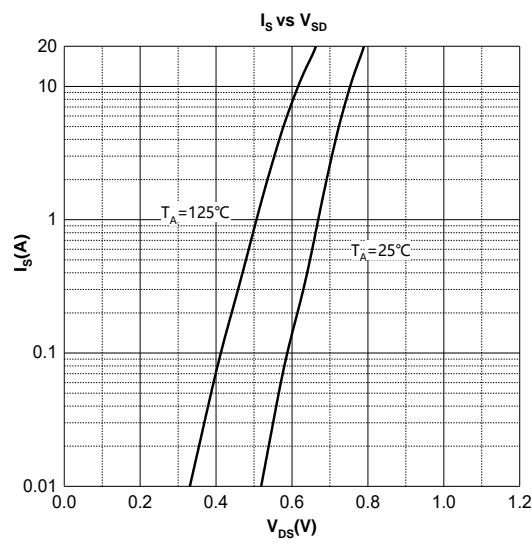
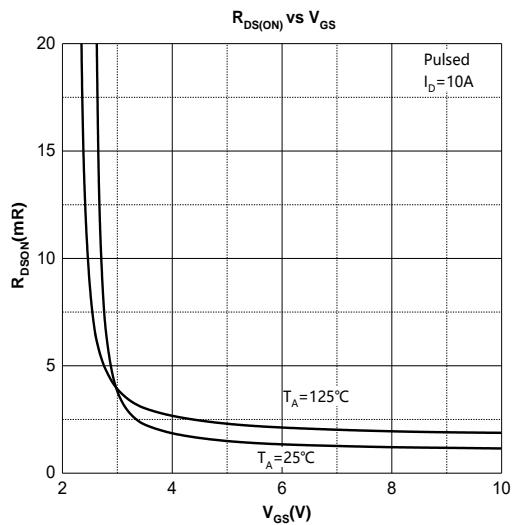
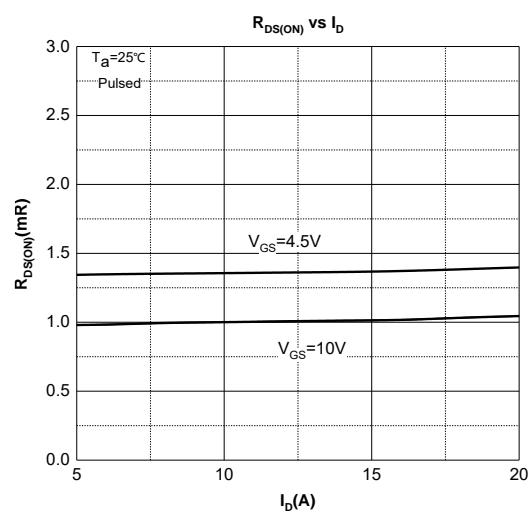
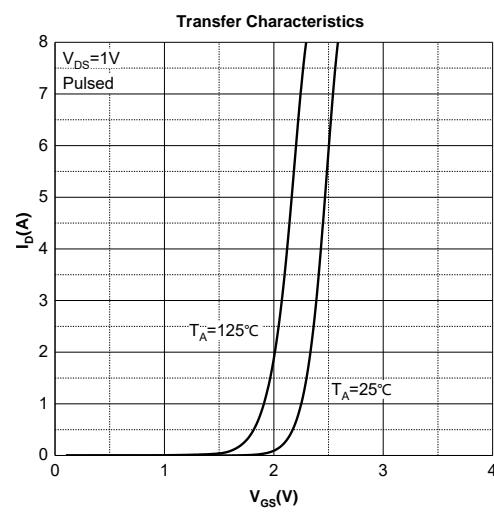
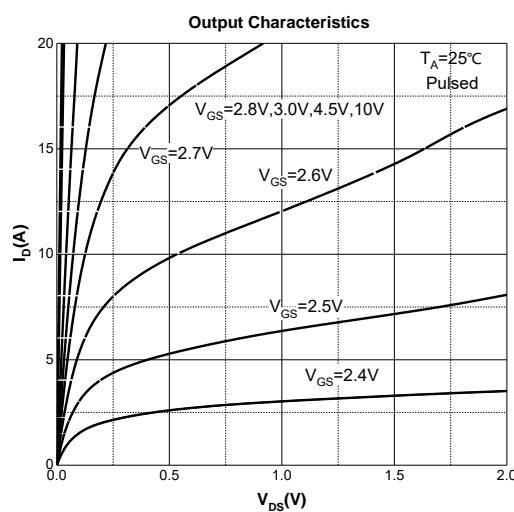
Parameter		Symbol	Value	Unit
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$T_C = 25^\circ\text{C}$	$I_D$	180	A
Continuous Drain Current <sup>6</sup>	$T_C = 100^\circ\text{C}$	$I_D$	67	A
Pulsed Drain Current <sup>2</sup>		$I_{DM}$	540	A
Single Pulsed Avalanche Current <sup>3</sup>		$I_{AS}$	67	A
Single Pulsed Avalanche Energy <sup>3</sup>		$E_{AS}$	1122	mJ
Power Dissipation <sup>5</sup>	$T_C = 25^\circ\text{C}$	$P_D$	119	W
Power Dissipation <sup>6</sup>	$T_C = 100^\circ\text{C}$	$P_D$	24	W
Thermal Resistance from Junction to Ambient <sup>6</sup>		$R_{\theta JA}$	50	°C/W
Thermal Resistance from Junction to Case		$R_{\theta JC}$	1.05	°C/W
Junction Temperature		$T_J$	150	°C
Storage Temperature		$T_{STG}$	-55~+150	°C

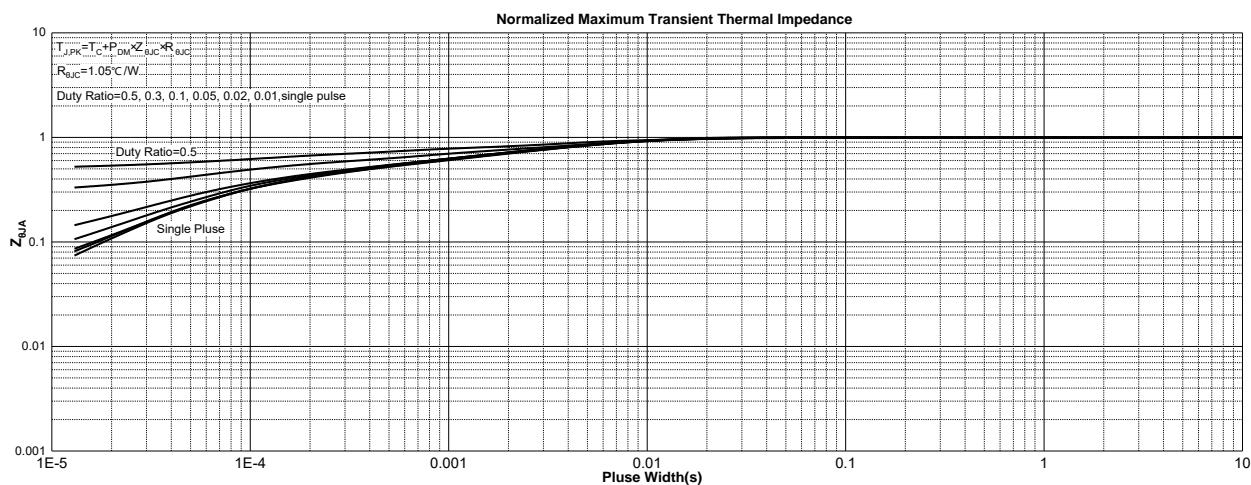
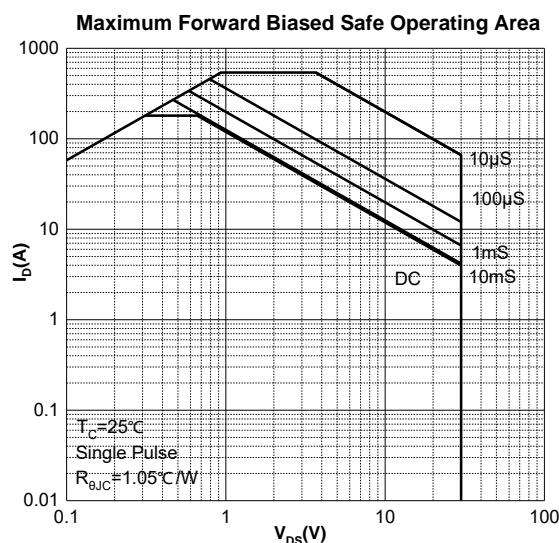
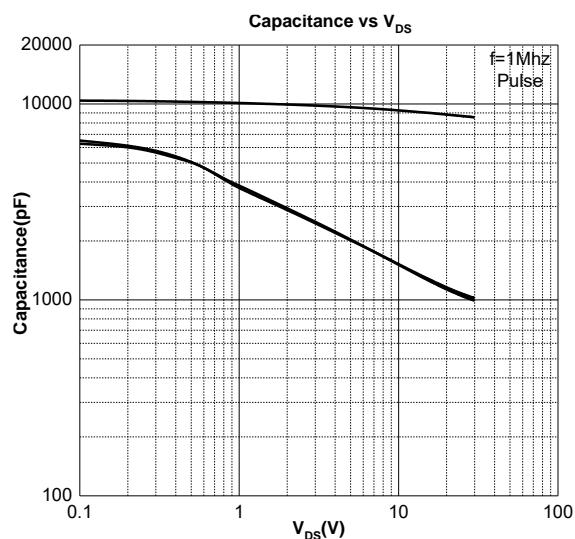
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

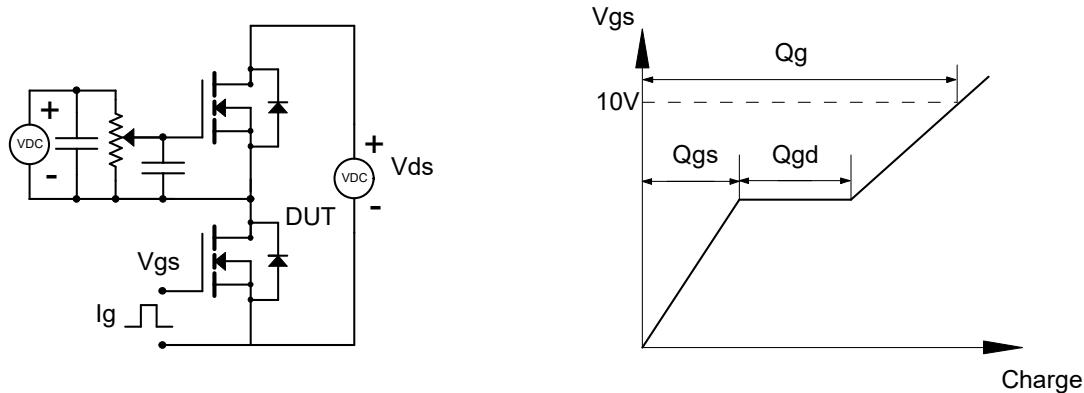
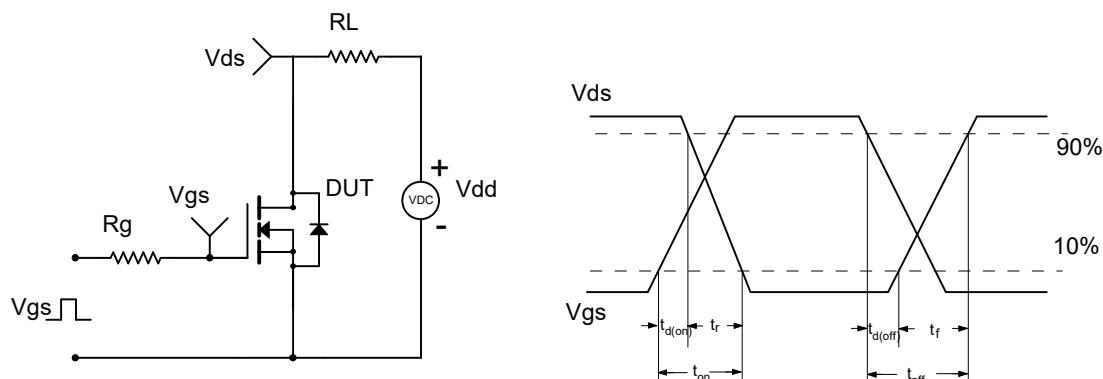
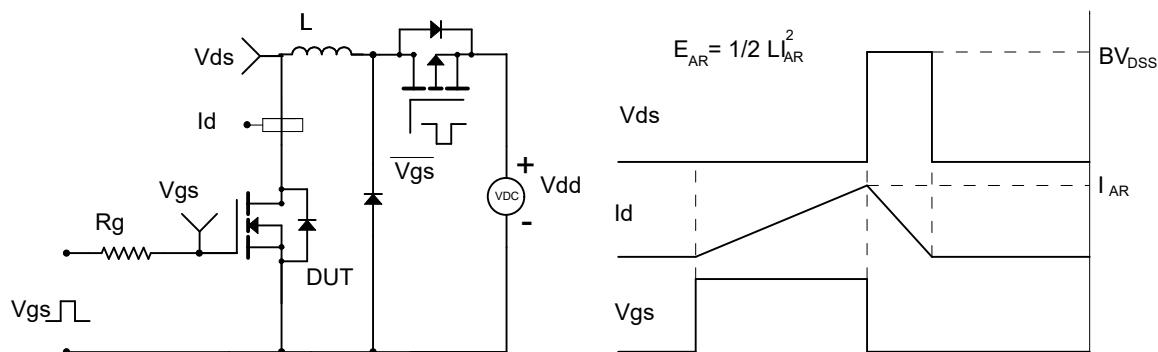
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 24V, V_{GS} = 0V$			1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
<b>On Characteristics<sup>4</sup></b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.5	3.0	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 30A$		1.05	1.4	$\text{m}\Omega$
		$V_{GS} = 4.5V, I_D = 10A$		1.4	1.9	
Forward Transconductance	$g_{FS}$	$V_{DS} = 10V, I_D = 10A$	20			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V, f = 1\text{MHz}$		9100		pF
Output Capacitance	$C_{oss}$			1325		
Reverse Transfer Capacitance	$C_{rss}$			1220		
Gate Resistance	$R_g$	$V_{DS} = 0V, V_{GS} = 0V, f = 1\text{MHz}$		1.2		$\Omega$
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 15V, V_{GS} = 10V, I_D = 20A$		123		nC
Gate-Source Charge	$Q_{gs}$			29.9		
Gate-Drain Charge	$Q_{gd}$			46.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15V, V_{GS} = 10V, R_L = 3\Omega$ $R_G = 3\Omega$		97.2		ns
Turn-On Rise Time	$t_r$			195		
Turn-Off Delay Time	$t_{d(off)}$			240		
Turn-Off Fall Time	$t_f$			102		
<b>Source-Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>4</sup>	$V_{SD}$	$V_{GS} = 0V, I_s = 10A$			1.2	V

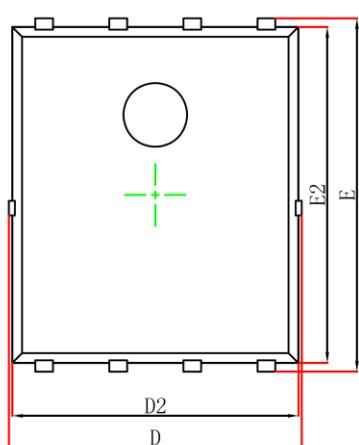
Notes :

- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.E<sub>AS</sub> condition:  $V_{DD} = 25V, V_{GS} = 10V, L = 0.5\text{mH}, R_G = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$ .
- 4.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 5.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .And device mounted on a large heatsink
- 6.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

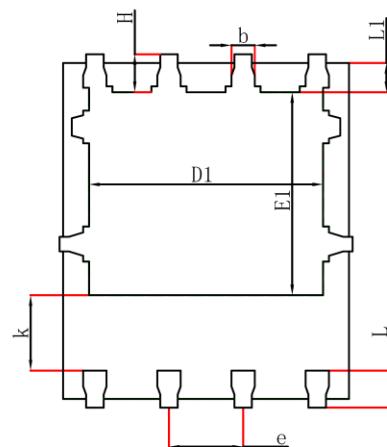
**Typical Characteristics**




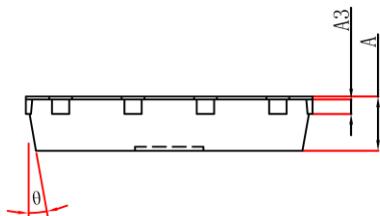
**Test Circuit**
**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveform**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**


**PDFN5X6-8L Package Information**


Top View  
[顶视图]



Bottom View  
[背视图]



Side View  
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.10	0.035	0.043
A3	0.254REF		0.010REF	
D	4.700	5.260	0.185	0.207
E	5.750	6.250	0.226	0.246
D1	3.560	4.500	0.140	0.177
E1	3.180	3.660	0.125	0.144
D2	4.700	5.100	0.185	0.201
E2	5.600	6.000	0.220	0.236
k	1.100	-	0.043	-
b	0.300	0.500	0.012	0.020
e	1.270TYP		0.050TYP	
L	0.510	0.710	0.020	0.028
L1	0.424	0.576	0.017	0.023
H	0.510	0.710	0.020	0.028
θ	8°	12°	8°	12°

**Attention:**

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
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